Data sheet acquired from Harris Semiconductor SCHS033C – Revised October 2003

# **BCD-to-Decimal Decoder**

High-Voltage Types (20-Volt Rating)

■ CD4028B types are BCD-todecimal or binary-to-octal decoders consisting of buffering on all 4 inputs, decodinglogic gates, and 10 output buffers. A BCD code applied to the four inputs, A to D, results in a high level at the selected one of 10 decimal decoded outputs. Similarly, a 3-bit binary code applied to inputs A through C is decoded in octal code at output 0 to 7 if D = "0". High drive capability is provided at all outputs to enhance dc and dynamic performance in high fan-out applications.

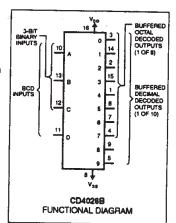
The CD4028B-Series types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (M, M96, MT, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

#### Features:

- BCD-to-decimal decoding or binary-to-octal decoding
- High decoded output drive capability
- "Positive logic" inputs and outputs.... decoded outputs go high on selection
- Medium-speed operation, . . .
- tpHL, tpLH = 80 ns (typ.) @ V<sub>DD</sub> = 10 V ■ Standardized, symmetrical output characteristics
- IO0% tested for guiescent current at 20 V
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 μA at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin (over full packagetemperature range):
  - 1 V at V<sub>DD</sub> = 5 V
  - 2 V at V<sub>DD</sub> = 10 V
- 2.5 V at V<sub>DD</sub> = 15 V
- 5-V, 10-V, and 15-V parametric ratings
  Meets all requirements of JEDEC
- Tentative Standard No. 138, "Standard Specifications for Description of 'B' Series CMOS Devices''

#### Applications:

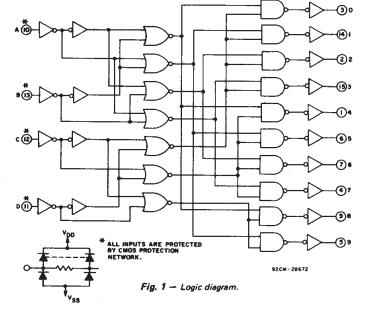
- Code conversion
  Indicator-tube decoder
- Address decoding—memory selection control



CD4028B Types

	· <u> </u>
4	₩ - V <sub>DD</sub>
2 22	15 3
0	14 j — 1
7 -4	13 — в
9	12 - C
5 6	14 haar 0
6 - 7	ю <b>⊢</b> ∧
'ss 8	9 8
L	
	9265-24471

Top View TERMINAL DIAGRAM



#### MAXIMUM RATINGS, Absolute-Maximum Values:

#### **TABLE I - TRUTH TABLE**

С	в		-									
	D	A	0	1	2	3	4	5	6	7	8	9
0	0	0	1	0	0	0	0	0	0	0	0	0
0	0	1	0	1	0	0	0	0	0	0	0	0
0	1	0	0	0	1	0	0	0	0	0	0	0
0	1	1	0	0	0	1	0	0	0	0	0	0
1	0	0	0	0	0	0	1	0	0	0	0	0
1	0	1	0	0	0	0	0	1	0	0	0	0
1	1	0	0	0	0	0	0	0	1	0	0	0
1	1	1	0	0	0	0	0	0	0	1	0	0
0	0	0	0	0	0	0	0	0	0	0	1	0
0	0	1	0	0	0	0	0	0	0	0	0	1
0	1	0	0	0	0	0	0	0	0	0	0	0
0	1	1	0	0	0	0	0	0	0	0	0	0
1	0	0	0	0	0	0	0	0	0	0	0	0
1	0	1	0	0	0	0	0	0	0	0	0	0
Ŧ	1	0	0	0	0	0	0	0	0	0	0	0
1	1	1	0	0	0	0	0	0	0	0	0	0
	0 0 1 1 1 1 0 0 0 1 1	0 0 0 1 1 0 1 0 1 1 1 1 1 1 0 0 0 0 0 1 0 1	0    0    1      0    1    0      1    1    0      1    0    1      1    1    0      1    1    1      1    1    0      1    1    1      0    0    0      1    1    0      0    0    1      0    1    1      0    0    1      1    0    0      1    0    0      1    0    1      1    0    0      1    0    1	0    0    1    0      0    1    0    0      0    1    1    0      1    0    0    0      1    0    1    0      1    0    1    0      1    1    0    0      1    1    1    0      0    0    0    0      0    0    1    0      0    1    0    0      0    1    0    0      1    0    0    0      1    0    0    0      1    0    0    0      1    0    0    0      1    0    0    0      1    0    1    0	0    0    1    0    1      0    1    0    0    0      0    1    1    0    0      1    0    0    0    0      1    0    1    0    0      1    0    1    0    0      1    1    0    0    0      1    1    1    0    0      0    0    0    0    0      0    0    1    0    0      0    1    0    0    0      0    1    0    0    0      0    1    0    0    0      1    0    0    0    0      1    0    0    0    0      1    0    1    0    0      1    0    0    0    0	0    0    1    0    1    0      0    1    0    0    0    1    1      0    1    1    0    0    0    1      0    1    1    0    0    0    0      1    0    1    0    0    0    0      1    1    0    0    0    0    0      1    1    1    0    0    0    0      1    1    1    0    0    0    0      0    0    0    0    0    0    0      0    1    0    0    0    0    0      0    1    0    0    0    0    0      1    0    0    0    0    0    0    0      1    0    0    0    0    0    0    0      1    0    0    0    0    0    0    0	0    0    1    0    1    0    0      0    1    0    0    0    1    0      0    1    1    0    0    0    1    0      1    1    0    0    0    0    0    1      1    0    0    0    0    0    0    0      1    1    0    0    0    0    0    0      1    1    0    0    0    0    0    0      1    1    0    0    0    0    0    0      1    1    0    0    0    0    0    0      0    0    0    0    0    0    0    0      0    1    0    0    0    0    0    0      0    1    0    0    0    0    0    0      1    0    0    0    0    0    0    0      1    0	0    0    1    0    1    0    0    0      0    1    0    0    0    1    0    0    0      0    1    1    0    0    0    1    0    0      1    0    0    0    0    0    0    1    0      1    0    1    0    0    0    0    0    1      1    0    1    0    0    0    0    0    0    1      1    1    0    0    0    0    0    0    0    0      1    1    0    0    0    0    0    0    0    0      1    1    0	0    0    1    0    1    0	0    0    1    0    1    0	0    0    1    0    1    0	0    0    1    0    1    0

#### **RECOMMENDED OPERATING CONDITIONS**

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

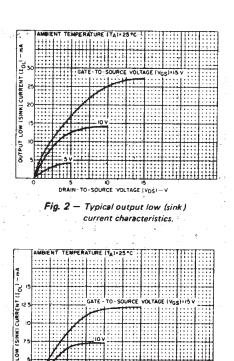
CHARACTERISTIC	.) t	LIMITS				
	MIN.	MAX.	UNITS			
Supply Voltage Range (For T <sub>A</sub> = Full Package						
Temperature Range)	3	18	V			

CHARACTER	CON	DITIO	IS	LIMI	TS AT	INDICAT	TED TE	MPER	ATURES	(°C)	UNITS
ISTIC	Vo	VIN	VDD						+25		UNITS
	(V)	(V)	(V).	-55	-40	+85	+125	Min.	Тур.	Max.	
Quiescent Device	-	0,5	5	5	5	150	150	- :	0.04	5	
Current,	-	0,10	10	10	10	300	300	-	.0.04	. 10	1
IDD Max.	-	0,15	15	20	20	600	600	- 7	0.04	20	μA
	-	0,20	20	100	100	3000	3000	-	0,08	100	1
Output Low	0.4	0,5	5	0.64	0.61	0,42	0,36	0.51	1	-	
(Sink) Current	0,5	0,10	10	1.6	1.5	1,1	0.9	1.3	2.6	-	1
IOL Min.	1,5	0,15	15	4.2	4	2.8	2.4	34	6.8	- 1	1
Output High	4.6	0,5	5	-0.64	-0,61	-0,42	-0.36	-0.51	1	-	mA
(Source) Current, IOH Min.	2.5	0,5	· 5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	-	1
	9.5	0,10	10	- 1.6	-1,5	-1.1	-0.9	-1.3	-2.6	- 1	1
	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	- 6.8	-	
Output Voltage:	-	0,5	5		0	.05		-	0	0.05	
Low-Level, Vol. Max.		0,10	10	_	0	.05		-	0	0.05	
•UL	-	0,15	15		0	05		-	0	0.05	v
Output Voltage:	-	0,5	5		4	95		4.95	5	-	, v
High Level, VOH Min	-	0,10	10		9	95		9,95	10	-	
VOH Min.	-	0,15	15		14	.95		14.95	15	-	
Input Low	0.5, 4.5		5		1	.5		_	-	1.5	
Voltage, Vij Max.	1, 9	-	10			3		_	-	3	
	1.5,13.5	_	15			4		-	-	4	
Input High	0.5, 4,5	-	5		3	.5		3,5	-	-	V
Voltage,	1, 9	-	10			7		7	-		
VIH Min.	1.5,13,5	-	15		1	1		11	-	-	
Input Current IIN Max.	-	0,18	18	±0,1	±0.1	±1	±1	-	±10 <sup>-5</sup>	±0.1	μΑ

#### STATIC ELECTRICAL CHARACTERISTICS



CHARACTERISTIC	TEST CONDITIONS	LIM	ITS	
CHARACTERISTIC	V <sub>DD</sub> (V)	Тур.	Max.	UNITS
Propagation Delay Time:	5	175	350	ns
<sup>t</sup> PHL <sup>, t</sup> PLH	10	80	160	
	15	60	120	
	5	100	200	
Transition Time	10	50	100	ns
<sup>t</sup> THL <sup>, t</sup> TLH	15	40	80	
Input Capacitance, C <sub>IN</sub>	-	5	7.5	pF



COMMERCIAL CMOS HIGH VOLTAGE ICS

3

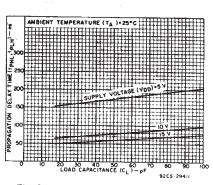


Fig. 3 – Minimum output low (sink) current characteristics.

Fig. 4 — Typical propagation delay time as a function of load capacitance.

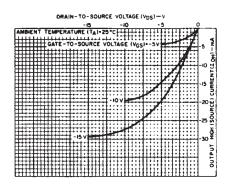


Fig. 5 – Typical output high (source) current characteristics.

#### **TABLE II - CODE CONVERSION CHART**

					INPU	та	ODES	;																	
				Hexa Deci		D	ecima	1																	
1	NP	UT	S	IT IARY	IT AY	EXCESS-3	EXCESS-3 GRAY	AIKEN	2-1					1	ου	ТР	UT	N	υM	8 E	R				
D	С	В	A	4-BI BIN	<b>4</b> 0 88	Ϋ́	Щ Х К	Ī	4-2-2-1	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
0	0	0	0	0	0			0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
0	0	0	1	1	1			1	1	0	1	Ô,	0	0	0	0	0	0	0	0	0	0	0	0	0
0	0	1	0	2	3		0	2	2	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0
0	0	1	1	3	2	0	3	3		0	Ð	0	1	0	0	0	0	0	0	0	0	0	0	0	0
0	1	0	0	4	7	1	4	4		0	0	0	0	1	0	0	0	0	Ó	0	0	0	0	0	0
0	1	0	1	5	6	2			3	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0
0	1	1	0	6	4	3	1		4	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0
0	1	1	1	7	5	4	2			0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
1	0	0	0	8	15	5				0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
1	0	0	1	9	14	6			5	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
1	0	1	0	10	12	7	9		6	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0
1	0	1	1	11	13	8		5		0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0
1	1	0	0	12	8	9	5	6		0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0
1	1	0	1	13	9		6	7	7	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0
1	1	1	0	14	11		8	8	8	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
1	1	1	1	15	10		7	9	9	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1

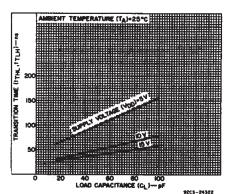


Fig. 8 - Typical transition time as a function of load capacitance.

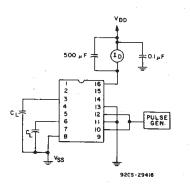


Fig. 10 - Dynamic power dissipation test circuit.

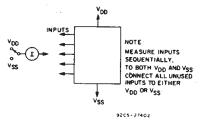


Fig. 9 - Input current test circuit.

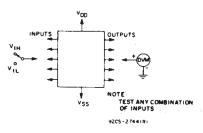
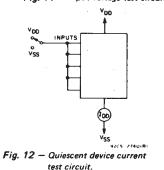


Fig. 11 - Input voltage test circuit.



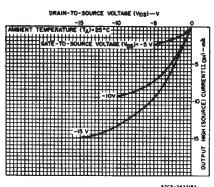
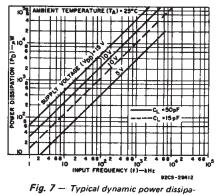
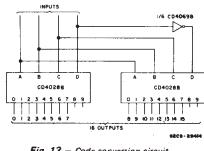


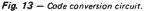
Fig. 6 — Minimum output high (source) current characteristics.



tion as a function of input frequency.

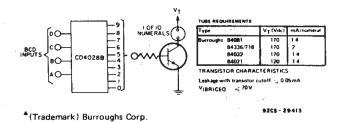
TYPICAL APPLICATIONS

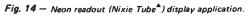


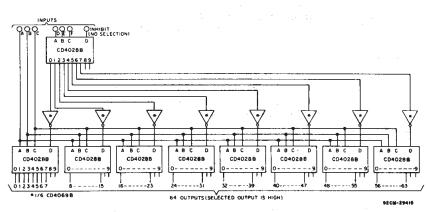


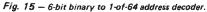
The circuit shown in Fig.13 converts any 4bit code to a decimal or hexadecimal code. Table 2 shows a number of codes and the decimal or hexadecimal number in these codes which must be applied to the input terminals of the CD4028B to select a particular output. For example: in order to get a high on output No. 8 the input must be either an 8 expressed in 4-Bit Binary code, a 15 expressed in 4-Bit Gray code, or a 5 expressed in Excess-3 code.

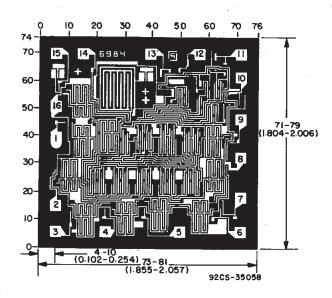
#### 3-82

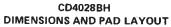












Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils  $(10^{-3} \text{ inch})$ .



### PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
CD4028BE	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-55 to 125	CD4028BE	Samples
CD4028BEE4	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-55 to 125	CD4028BE	Samples
CD4028BF	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	CD4028BF	Samples
CD4028BF3A	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	CD4028BF3A	Samples
CD4028BM	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4028BM	Samples
CD4028BM96	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4028BM	Samples
CD4028BMG4	ACTIVE	SOIC	D	16	40	TBD	Call TI	Call TI	-55 to 125		Samples
CD4028BMT	ACTIVE	SOIC	D	16	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4028BM	Samples
CD4028BNSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4028B	Samples
CD4028BNSRG4	ACTIVE	SO	NS	16	2000	TBD	Call TI	Call TI	-55 to 125		Samples
CD4028BPW	ACTIVE	TSSOP	PW	16	90	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CM028B	Samples
CD4028BPWR	ACTIVE	TSSOP	PW	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CM028B	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW**: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.



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## PACKAGE OPTION ADDENDUM

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

#### OTHER QUALIFIED VERSIONS OF CD4028B, CD4028B-MIL :

• Catalog : CD4028B

Military : CD4028B-MIL

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications



Texas

STRUMENTS

### TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CD4028BM96	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
CD4028BNSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
CD4028BPWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1



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## PACKAGE MATERIALS INFORMATION

9-Aug-2022



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CD4028BM96	SOIC	D	16	2500	340.5	336.1	32.0
CD4028BNSR	SO	NS	16	2000	356.0	356.0	35.0
CD4028BPWR	TSSOP	PW	16	2000	356.0	356.0	35.0

### TEXAS INSTRUMENTS

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9-Aug-2022

### TUBE



### - B - Alignment groove width

#### \*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
CD4028BE	N	PDIP	16	25	506	13.97	11230	4.32
CD4028BE	N	PDIP	16	25	506	13.97	11230	4.32
CD4028BEE4	N	PDIP	16	25	506	13.97	11230	4.32
CD4028BEE4	N	PDIP	16	25	506	13.97	11230	4.32
CD4028BM	D	SOIC	16	40	507	8	3940	4.32
CD4028BPW	PW	TSSOP	16	90	530	10.2	3600	3.5

# **NS0016A**



## **PACKAGE OUTLINE**

SOP - 2.00 mm max height

SOP



#### NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing
- Per ASME Y14.5M.
  This drawing is subject to change without notice.
  This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.



# NS0016A

## **EXAMPLE BOARD LAYOUT**

### SOP - 2.00 mm max height

SOP



NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



## NS0016A

## **EXAMPLE STENCIL DESIGN**

### SOP - 2.00 mm max height

SOP



NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

8. Board assembly site may have different recommendations for stencil design.



D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



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## D (R-PDSO-G16) PLASTIC SMALL OUTLINE Stencil Openings (Note D) Example Board Layout (Note C) –16x0,55 -14x1,27 -14x1,27 16x1,50 5,40 5.40 Example Non Soldermask Defined Pad Example Pad Geometry (See Note C) 0,60 .55 Example 1. Solder Mask Opening (See Note E) -0,07 All Around

NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



# **PW0016A**



## **PACKAGE OUTLINE**

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



## PW0016A

# **EXAMPLE BOARD LAYOUT**

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



## PW0016A

# **EXAMPLE STENCIL DESIGN**

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

9. Board assembly site may have different recommendations for stencil design.



<sup>8.</sup> Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

### MECHANICAL DATA

#### PLASTIC SMALL-OUTLINE PACKAGE

#### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



J (R-GDIP-T\*\*) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



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